

1. Description

The LTR-303ALS-01 is a low voltage I²C digital light sensor [ALS] in a low cost miniature chipled lead-free surface mount package. This sensor converts light intensity to a digital output signal capable of direct I²C interface. It provides a linear response over a wide dynamic range from 0.01 lux to 64k lux and is well suited to applications under high ambient brightness. There are altogether six gain settings (1X, 2X, 4X, 8X, 48X and 96X) available for user to configure.

The sensor supports an interrupt feature that removes the need to poll the sensor for a reading which improves system efficiency. The sensor also supports several features that help to minimize the occurrence of false triggering. This CMOS design and factory-set one time trimming capability ensure minimal sensor-to-sensor variations for ease of manufacturability to the end customers.

2. Features

- I²C interface (Fast Mode @ 400kbit/s)
- Ultra-small 6-pin ChipLED package
- 2.0mm(L), 2.0mm(B), 0.7mm(H)
- Built-in temperature compensation circuit
- · Low active power consumption with standby mode
- Supply voltage range from 2.4V to 3.6V capable of 1.7V logic voltage
- Operating temperature range from -30□C to +70□C
- RoHS and Halogen free compliant
- · Close to human eye spectral response
- Immunity to IR / UV Light Source
- Automatically rejects 50 / 60 Hz lightings flicker
- Full dynamic range from 0.01 lux to 64k lux
- 16-bit effective resolution



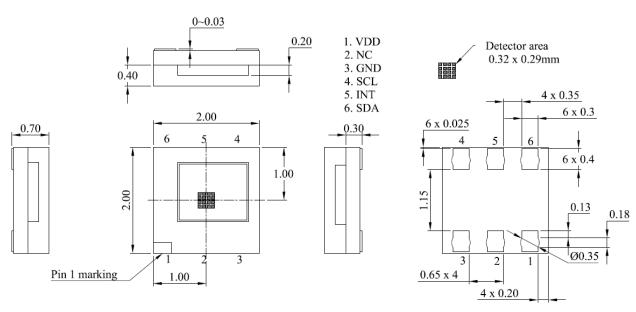
3. Applications

- Back-lighting Control in mobile/portable devices
- Touch Panel Control in mobile/portable devices

4. Ordering Information

Part Number	Packaging Type	Package	Quantity
LTR-303ALS-01	Tape and Reel	6-pin chipled package	2500

5. Outline Dimensions

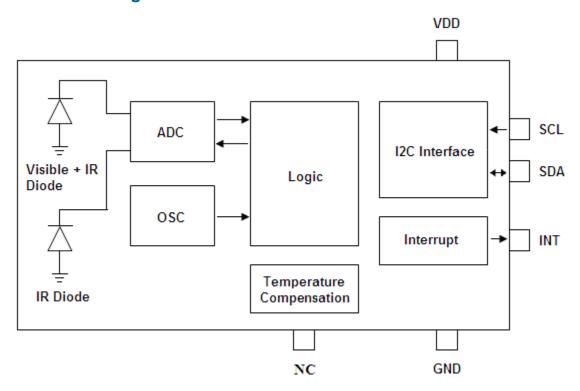


- 1. All dimensions in mm
- 2. Tolerances is +/-0.2
- 3. LTC reserve the right to to change the drawing till final datasheet release

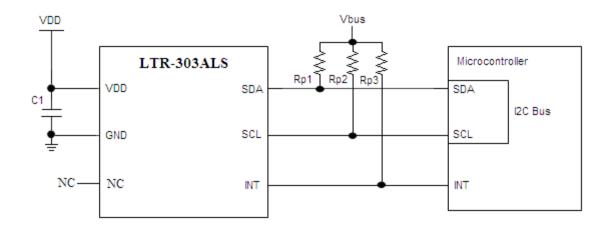
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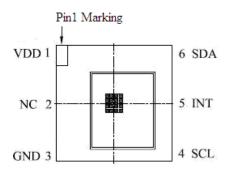
6. Functional Block Diagram



7. Application Circuit







I/O Pins Configuration Table

Pin	I/O Type	Symbol	Description
1		VDD	Power Supply Voltage
2		NC	No connection to this pin
3		GND	Ground
4	I	SCL*	I ² C serial clock. This pin is an open drain input.
5	0	INT*	Level Interrupt Pin. This pin is an open drain output.
6	I/O	SDA*	I ² C serial data. This pin is an open drain input / output.

^{*} Note: For noisy environment, add 10pF capacitor from signal to GND for additional noise filtering.

Recommended Application Circuit Components

Component	Recommended Value
Rp1, Rp2, Rp3 [1]	1 k Ω to 10 k Ω
C1	1uF ±20%, X7R / X5R Ceramic

[1] Selection of pull-up resistors value is dependent on bus capacitance values. For more details, please refer to I²C Specifications: http://www.nxp.com/documents/user_manual/UM10204.pdf



8. Ratings and Specifications

Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Rating	Unit
Supply Voltage	VDD	3.8	V
Digital Voltage Range	SCL, SDA, INT	-0.5 to 3.8	V
Digital Output Current	SCL, SDA, INT	-1 to 20	mA
Storage Temperature	T_{stg}	-40 to 100	°C

Note: Exceeding these ratings could cause damage to the sensor. All voltages are with respect to ground. Currents are positive into, negative out of the specified terminal.

Recommended Operating Conditions

Description	Symbol	Min.	Тур.	Max.	Unit	
Supply Voltage	VDD	2.4		3.6	V	
Interface Bus Power Supply Voltage	V_{IO}	1.7		3.6	V	
I ² C Bus Input Pin High Voltage	V _{IH} SCL,				V	
- C bus input rintingii voltage	V _{IH} SDA				V	
I ² C Bus Input Pin Low Voltage	V _{IL} SCL,			0.6	V	
T C Bus Input Fin Low Voltage	V_{IL} SDA	V _{IL} SDA		0.6	V	
Operating Temperature	T_{ope}	-30		70	°C	

Electrical & Optical Specifications

All specifications are at VDD = 3.0V, T_{ope} = 25°C, unless otherwise noted.

Parameter	Min.	Тур.	Max.	Unit	Condition
Active Supply Current			220	uA	Active Mode, T _{ope} = 25°C, VDD=3.6V Integration Time : 100ms Measurement rate : 200ms
Standby Current			5	uA	Standby / Sleep Mode
Initial Startup Time	100			ms	(Note 1)
Wakeup Time from Standby			10	ms	(Note 1)

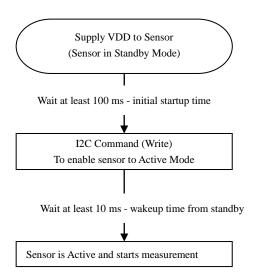


Light Sensor

Parameter	Min.	Тур.	Max.	Unit	Condition
Full Scale ADC Count			65535	count	
Dark ADC Count	0		6	count	Ch0, Lux = 0
	0		6	count	Ch1, Lux = 0
ADC Count (Coin_06)	3250		6100	count	Ch0 (see note 2) white LED 200 Lux Integration Time: 50ms Measurement Time: 100ms
ADC Count (Gain=96) @200Lux	1050		1950	count	Ch1 (see note 2) White LED 200 Lux Integration Time: 50ms Measurement Time: 100ms
	0.15		0.35	Ratio	Ch1/(Ch0 + Ch1)

Notes:

Startup Sequence



LiteOn White LED color temperature 10000K.



Typical Performance Curve

All specifications are at VDD = 3.0V, T_{ope} = 25°C, unless otherwise noted.

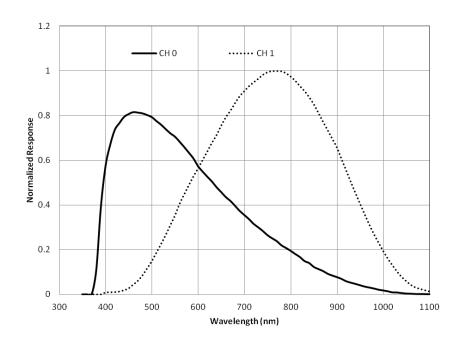


Figure 1: Normalized Spectral Response

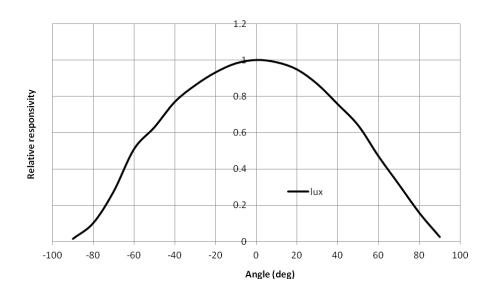


Figure 2: Viewing angle



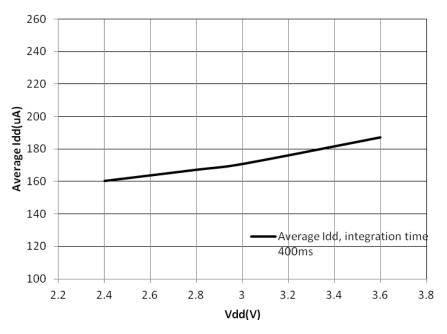


Figure 3 : Vdd versus Average Idd

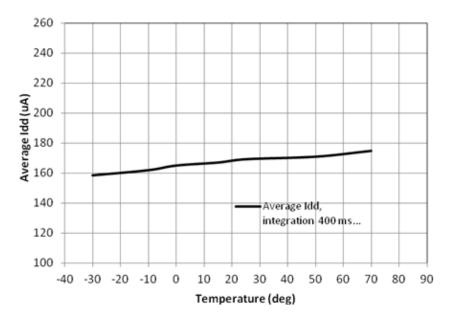


Figure 4: Average Idd versus temperature



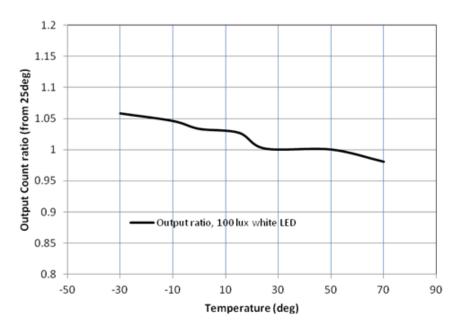


Figure 5 : Output count ratio versus temperature

Lux Formula

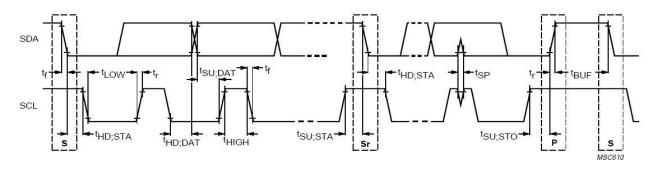
Refer to Appendix A for the lux formula



AC Electrical Characteristics

All specifications are at VBus = 1.8V, T_{ope} = 25°C, unless otherwise noted.

Parameter	Symbol	Min.	Max.	Unit
SCL clock frequency	$f_{ extit{SCL}}$	1	400	kHz
Bus free time between a STOP and START condition	t_{BUF}	1.3		us
Hold time (repeated) START condition. After this period, the first clock pulse is generated	$t_{HD;STA}$	0.6		us
LOW period of the SCL clock	t_{LOW}	1.3		us
HIGH period of the SCL clock	t_{HIGH}	0.6		us
Set-up time for a repeated START condition	$t_{SU;STA}$	0.6		us
Set-up time for STOP condition	$t_{SU;STO}$	0.6		us
Rise time of both SDA and SCL signals	t_r	30	300	ns
Fall time of both SDA and SCL signals	t_f	30	300	ns
Data hold time	$t_{HD;DAT}$	0.3	0.9	us
Data setup time	$t_{SU;DAT}$	100		ns
Pulse width of spikes which must be suppressed by the input filter	t_{SP}	0	50	ns



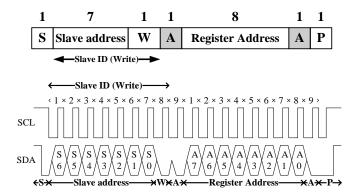
Definition of timing for I²C bus



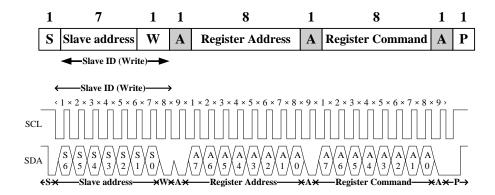
9. Principles of Operation

I²C Protocols

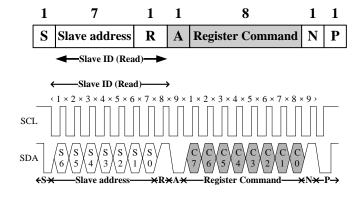
· I²C Write Protocol (type 1):



· I²C Write Protocol (type 2):

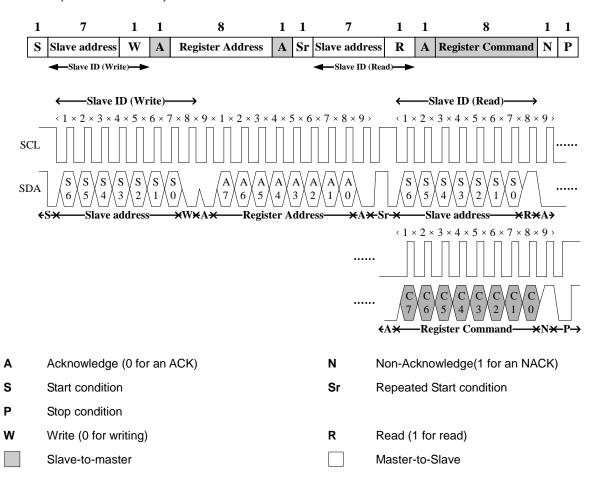


· I²C Read Protocol:





· I²C Read (Combined format) Protocol:



I²C Slave Address

The 7 bits slave address for this sensor is 0x29H. A read/write bit should be appended to the slave address by the master device to properly communicate with the sensor.

I ² C Slave Address									
Command	nd (0x29H)						W/R		
Туре	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	value
Write	0	1	0	1	0	0	1	0	0x52H
Read	0	1	0	1	0	0	1	1	0x53H



Register Set

Addr	R/W	Register Name	Description	Reset Value
0x80	R/W	ALS_CONTR	ALS operation mode control SW reset	0x00
0x85	R/W	ALS_MEAS_RATE	ALS measurement rate in active mode	0x01
0x86	R	PART_ID	Part Number ID and Revision ID	0xA0
0x87	R	MANUFAC_ID	Manufacturer ID	0x05
0x88	R	ALS_DATA_CH1_0	ALS measurement CH1 data, lower byte	0x00
0x89	R	ALS_DATA_CH1_1	ALS measurement CH1 data, upper byte	0x00
0x8A	R	ALS_DATA_CH0_0	ALS measurement CH0 data, lower byte	0x00
0x8B	R	ALS_DATA_CH0_1	ALS measurement CH0 data, upper byte	0x00
0x8C	R	ALS_STATUS	ALS new data status	0x00
0x8F	R/W	INTERRUPT	Interrupt settings	0x08
0x97	R/W	ALS_THRES_UP_0	ALS interrupt upper threshold, lower byte	0xFF
0x98	R/W	ALS_THRES_UP_1	ALS interrupt upper threshold, upper byte	0xFF
0x99	R/W	ALS_THRES_LOW_0	ALS interrupt lower threshold, lower byte	0x00
0x9A	R/W	ALS_THRES_LOW_1	ALS interrupt lower threshold, upper byte	0x00
0x9E	R/W	INTERRUPT PERSIST	ALS Interrupt persist setting	0x00

Notes:

- 1) When reading ALS data registers, read sequence should always be from lower address to higher address (E.g. For ALS data, Ch1 data should be read first followed by Ch0 data. Read sequence should be 0x88, 0x89, 0x8A, 0x8B. When 0x8B is read, all four ALS data registers will be populated with new set of data).
- 2) When setting of INTERRUPT register (addr 0x8F) is necessary, it should be done before the device is in Active mode.



ALS_CONTR Register (0x80)

The ALS_CONTR register controls the ALS Gain setting, ALS operation modes and software (SW) reset for the sensor. The ALS sensor can be set to either standby mode or active mode. At either of these modes, the I²C circuitry is always active. The default mode after power up is standby mode. During standby mode, there is no ALS measurement performed but I²C communication is allowed to enable read/write to all the registers

0x80		ALS_CONTR (default = 0x00)						
	В7	В6	В5	B4	В3	B2	B1	В0
		Reserved			ALS Gain			ALS Mode

Field	Bits	Default	Туре	Descriptio	n
Reserved	7:5	000			MUST write to 000 (default)
				000	Gain 1X → 1 lux to 64k lux (default)
				001	Gain 2X → 0.5 lux to 32k lux
				010	Gain 4X → 0.25 lux to 16k lux
ALC Cain	4.0	000	DW	011	Gain 8X → 0.125 lux to 8k lux
ALS Gain	4:2	000	RW	100	Reserved
				101	Reserved
				110	Gain 48X → 0.02 lux to 1.3k lux
				111	Gain 96X → 0.01 lux to 600 lux
				0	Initial start-up procedure is NOT started (default)
SW reset	1	0	RW	4	Initial start-up procedure is started, bit has default
				1	value of 0 after start-up
ALC made	0	0	DW	0	Stand-by mode (default)
ALS mode	0	0	RW	1	Active mode



ALS_MEAS_RATE Register (0x85)

The ALS_MEAS_RATE register controls the integration time and timing of the periodic measurement of the ALS in active mode. ALS Measurement Repeat Rate is the interval between ALS_DATA registers update. ALS Integration Time is the measurement time for each ALS cycle. ALS Integration Time must be set to be equal or smaller than the ALS Measurement Repeat Rate. If ALS Integration Time is set to be bigger than ALS Measurement Repeat Rate, it will be automatically reset to be equal to ALS Measurement Repeat Rate by the IC internally.

0x85		ALS_MEAS_RATE (default = 0x03)								
	В7	B7 B6 B5 B4 B3 B2 B1 B0								
	Rese	erved	ALS	Integration	Time	ALS Mea	surement Re	peat Rate		

Field	Bits	Default	Туре	Descripti	on
Reserved	7:6	00			
				000	100ms (default)
				001	50ms
				010	200ms
ALS	5.2	000	DW	011	400ms
integration time	5:3	000	RW	100	150ms
				101	250ms
				110	300ms
				111	350ms
				000	50ms
				001	100ms
				010	200ms
ALS	2:0	011	RW	011	500ms (default)
measurement rate	2.0	011	KVV	100	1000ms
				101	
				110	2000ms
				111	



PART_ID Register (0x86) (Read Only)

The PART_ID register defines the part number and revision identification of the sensor.

0x86		PART_ID (default = 0xA0)								
	В7	B7 B6 B5 B4 B3 B2 B1 B0								
		Part Nu	mber ID		Revision ID					

Field	Bits	Default	Type	Description
Part Number ID	7:4	1010	R	Part ID 0x0AH
Revision ID	3:0	0000	R	Revision ID 0x00H

MANUFAC_ID Register (0x87) (Read Only)

The MANUFAC_ID register defines the manufacturer identification of the sensor.

0x87		MANUFAC_ID (default = 0x05)									
	В7	B7 B6 B5 B4 B3 B2 B1 B0									
		Manufacturer ID									

Field	Bits	Default	Туре	Description
Manufacturer ID	7:0	00000101	R	Manufacturer ID (0x05H)



ALS_DATA_CH1 Register (0x88 / 0x89) (Read Only)

The ALS_DATA registers should be read as a group, with the lower address read back first (i.e. read 0x88 first, then read 0x89). These two registers should also be read before reading channel-0 data (from registers 0x8A, 0x8B).

When the I²C read operation starts, all four ALS data registers are locked until the I²C read operation of register 0x8B is completed. This will ensure that the data in the registers is from the same measurement even if an additional integration cycle ends during the read operation. New measurement data is stored into temporary registers and the ALS_DATA registers are updated as soon as there is no on-going I²C read operation.

The ALS ADC channel-1 data is expressed as a 16-bit data spread over two registers. The ALS_DATA_CH1_0 and ALS_DATA_CH1_1 registers provide the lower and upper byte respectively.

0x88		ALS_DATA_CH1_0 (default = 0x00)									
	В7	B7 B6 B5 B4 B3 B2 B1 B0									
		ALS Data Ch1 Low									

0x89	ALS_DATA_CH1_1 (default = 0x00)									
	В7	В6	B5	B2	B1	В0				
		ALS Data Ch1 High								

Field	Address	Bits	Default	Туре	Description
ALS Data Ch1 Low	0x88	7:0	00000000	R	ALS ADC channel 1 lower byte data
ALS Data Ch1 High	0x89	7:0	00000000	R	ALS ADC channel 1 upper byte data



ALS_DATA_CH0 Register (0x8A / 0x8B) (Read Only)

These two registers should be read after reading channel-1 data (from registers 0x88, 0x89). Lower address register should be read first (i.e. read 0x8A first, then read 0x8B). See ALS_DATA_CH1 register information above. The ALS ADC channel-0 data is expressed as a 16-bit data spread over two registers. The ALS_DATA_CH0_0 and ALS_DATA_CH0_1 registers provide the lower and upper byte respectively.

0x8A		ALS_DATA_CH0_0 (default = 0x00)									
	В7	В6	B5	B4	В3	B2	B1	В0			
		ALS Data Ch0 Low									

0x8B		ALS_DATA_CH0_1 (default = 0x00)									
	В7	B7 B6 B5 B4 B3 B2 B1									
		ALS Data Ch0 High									

Field	Address	Bits	Default	Туре	Description
ALS Data Ch0 Low	0x8A	7:0	00000000	R	ALS ADC channel 0 lower byte data
ALS Data Ch0 High	0x8B	7:0	00000000	R	ALS ADC channel 0 upper byte data



ALS_ STATUS Register (0x8C) (Read Only)

The ALS_STATUS register stores the information about ALS data status. New data means data has not been read yet. When the measurement is completed and data is written to the data register, the data status bit will be set to logic 1. When the data register is read, the data status bit will be set to logic 0.

Interrupt status determines if the ALS interrupt criteria are met. It will check if the ALS measurement data is outside of the range defined by the upper and lower threshold limits.

0x8C	ALS_STATUS (default = 0x00)									
	В7	В6	В5	В4	В3	B2	B1	В0		
	ALS Data Valid		ALS Gain		ALS Interrupt Status	ALS Data Status	Rese	erved		

Field	Bits	Default	Туре	Descripti	on
ALS Data Valid	7	0	R	0	ALS Data is Valid (default)
ALS Data Valid	,	0	K	1	ALS Data is Invalid
				000	ALS measured data in Gain 1X (default)
				001	ALS measured data in Gain 2X
				010	ALS measured data in Gain 4X
ALS Data Gain	C. 4	000	R	011	ALS measured data in Gain 8X
Range	6:4	000	K	100	Invalid
				101	Invalid
				110	ALS measured data in Gain 48X
				111	ALS measured data in Gain 96X
ALS interrupt	2	0	R	0	Interrupt signal INACTIVE (default)
status	3	0	K		Interrupt signal ACTIVE
ALS data	0		Б	0	OLD data (data already read), (default)
status	status 2	0	R	1	NEW data (first time data is being read)
Reserved	1:0	00	R		Don't care



INTERRUPT Register (0x8F) (Read Only)

The INTERRUPT register controls the operation of the interrupt pin and functions. When the Interrupt Mode is set to 00, the INT output pin 2 is inactive / disabled and will not trigger any interrupt.

Note that when this register is to be set with values other than its default values, it should be set before device is in Active mode.

0x8F	INTERRUPT (default = 0x08)									
	В7	В6	В5	B4	В3	B2	B1	В0		
			Reserved	Interrupt Polarity	Interrupt Mode	Reserved				

Field	Bits	Default	Туре	Description		
RESERVED	7:3	00001			Must write as 00000 Bit B3 is "1" (default) but it has no impact on performance	
Interrupt	2	0	RW	0	INT pin is considered active when it is a logic 0 (default)	
Polarity				1	INT pin is considered active when it is a logic 1	
Interrupt Mode	1	0	RW	0	Interrupt pin is INACTIVE / high impedance state (default)	
				1	ALS measurement can trigger interrupt	
RESERVED	0	0			Don't care	



ALS_THRES Register (0x97 / 0x98 / 0x99 / 0x9A)

The ALS_THRES_UP and ALS_THRES_LOW registers determines the upper and lower limit of the interrupt threshold value respectively. These two values form a range and the interrupt function compares if the measurement value in ALS_DATA registers is inside or outside the range. The interrupt function is active if the measurement data is outside the range defined by the upper and lower limits. The data format for ALS_THRES must be the same as ALS_DATA registers.

0x97	ALS_THRES_UP_0 (default = 0xFF)								
	В7	B7 B6 B5 B4 B3 B2 B1 B0							
	ALS Upper Threshold Low								

0x98	ALS_THRES_UP_1 (default = 0xFF)								
	В7	B7 B6 B5 B4 B3 B2 B1 B0							
	ALS Upper Threshold High								

0x99	ALS_THRES_LOW_0 (default = 0x00)								
	В7	B7 B6 B5 B4 B3 B2 B1 B0							
	ALS Lower Threshold Low								

0x9A	ALS_THRES_LOW_1 (default = 0x00)									
	В7	B7 B6 B5 B4 B3 B2 B1 B0								
	ALS Lower Threshold High									

Field	Address	Bits	Default	Туре	Description
ALS upper threshold Low	0x97	7:0	11111111	RW	ALS upper threshold lower byte data
ALS upper threshold High	0x98	7:0	11111111	RW	ALS upper threshold upper byte data
ALS lower threshold Low	0x99	7:0	00000000	RW	ALS lower threshold lower byte data
ALS lower threshold High	0x9A	7:0	00000000	RW	ALS lower threshold upper byte data



INTERRUPT PERSIST Register (0x9E)

The INTERRUPT PERSIST register controls the N number of times the measurement data is outside the range defined by the upper and lower threshold limits before asserting the INT output pin 2.

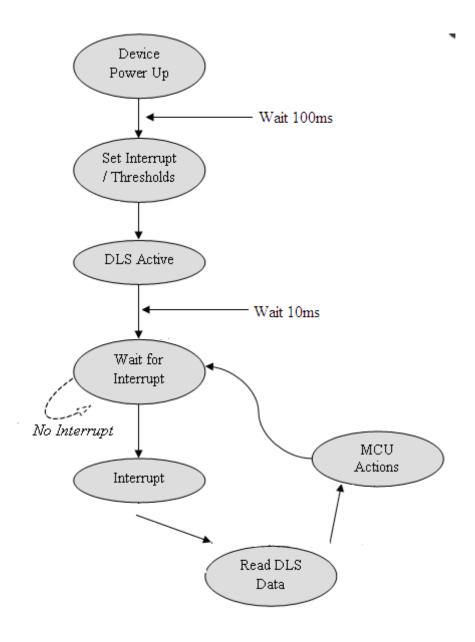
0x9E	INTERRUPT PERSIST (default = 0x00)								
	В7	В6	B5	B4	В3	B2	B1	В0	
		RESE	RVED		ALS Persist				

Field	Bits	Default	Туре	Description		
RESERVED	7:4	0000		Don't ca	re	
					Every ALS value out of threshold range (default)	
ALC Daviet	2.0	0000	DW	0001	2 consecutive ALS values out of threshold range	
ALS Persist	3:0	0000	RW			
				1111	16 consecutive ALS values out of threshold range	



10. Device Operation(using Interrupt)

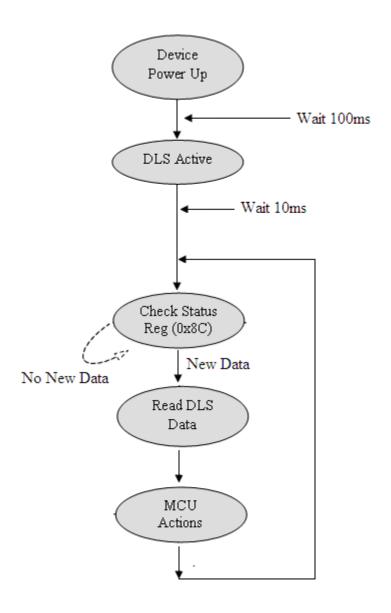
Below flow diagram illustrates the LTR-303ALS operation.





11. Device Operation(without using Interrupt)

Below flow diagram illustrates the LTR-303ALS operation without the use of interrupts.





12. Pseudo Codes Examples

Control Registers

// The Control Register defines the operating modes and gain settings of the ALS of LTR-303.

// Default settings is 0x00 (in Standby mode).

Slave_Addr = 0x29 // Slave address of LTR-303 device

// Enable ALS

Register_Addr = 0x80 // ALS_CONTR register

Command = 0x01 // For Gain X1

// For Gain X96, Command = 0x1D

WriteByte(Slave_Addr, Register_Addr, Command)

ALS Measurement Rate

// The ALS_MEAS_RATE register controls the ALS integration time and measurement rate.

// Default setting of the register is 0x03 (integration time 100ms, repeat rate 500ms)

Slave_Addr = 0x29 // Slave address of LTR-303 device

// Set ALS Integration Time 200ms, Repeat Rate 200ms

Register_Addr = 0x85 // ALS_MEAS_RATE register

Command = 0x12 // Int time = 200ms, Meas rate = 200ms

// For Int time = 400ms, Meas rate = 500ms, Command = 0x1B

WriteByte(Slave_Addr, Register_Addr, Command)

ALS Data Registers (Read Only)

// The ALS Data Registers contain the ADC output data for the respective channel.

// These registers should be read as a group, with the lower address being read first.

Slave_Addr = 0x29 // Slave address of LTR-303 device

// Read back ALS_DATA_CH1

Register_Addr = 0x88 // ALS_DATA_CH1 low byte address

ReadByte(Slave_Addr, Register_Addr, Data0)

Register_Addr = 0x89 // ALS_DATA_CH1 high byte address

ReadByte(Slave_Addr, Register_Addr, Data1)

// Read back ALS_DATA_CH0

Register_Addr = 0x8A // ALS_DATA_CH0 low byte address

ReadByte(Slave_Addr, Register_Addr, Data2) Register_Addr = 0x8B

ReadByte(Slave_Addr, Register_Addr, Data3)

// ALS_DATA_CH0 high byte address

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ALS Status Register (Read only)

// The ALS_STATUS Register contains the information on ALS data availability status. This register is read only.

Slave_Addr = 0x29 // Slave address of LTR-303 device

// Read back Register

Register_Addr = 0x8C // ALS_STATUS register address

ReadByte(Slave_Addr, Register_Addr, Data)

ALS_Data_Valid = Data & 0x80 // ALS_Data_Valid = 0x00 → ALS New Data is valid (usable)

// ALS_Data_Valid = 0x80 → ALS New Data is invalid, discard and wait for

new ALS data

Interrupt Registers

```
// The Interrupt register controls the operation of the interrupt pins and function.
```

// The default value for this register is 0x08 (Interrupt inactive)

// Note that when this register is to be set with values other than its default values,

// it should be set before device is in active mode.

Slave_Addr = 0x29 // Slave address of LTR-303 device

// Set Interrupt Polarity for ALS Active Low trigger

Register_Addr = 0x8F // Interrupt Register address
Command = 0x0A // Interrupt is Active Low ALS trigger

// For Active High Interrupt ALS trigger, Command = 0x0E

WriteByte(Slave_Addr, Register_Addr, Command)

ALS Threshold Registers

// The ALS_THRES_UP and ALS_THRES_LOW registers determines the upper and lower limit of the interrupt threshold value. // Following example illustrates the setting of the ALS threshold window of decimal values of 200 (lower threshold) // and 1000 (upper threshold)

Slave_Addr = 0x29 // Slave address of LTR-303 device

// Upper Threshold Setting (decimal 1000)

ALS_Upp_Threshold_Reg_0 = 0x97 // ALS Upper Threshold Low Byte Register address ALS_Upp_Threshold_Reg_1 = 0x98 // ALS Upper Threshold High Byte Register address

Data1 = 1000 >> 8 // To convert decimal 1000 into two eight bytes register values

Data0 = 1000 & 0xFF

WriteByte(Slave_Addr, ALS_Upp_Threshold_Reg_0, Data0) WriteByte(Slave_Addr, ALS_Upp_Threshold_Reg_1, Data1)

// Lower Threshold Setting (decimal 200)

ALS_Low_Threshold_Reg_0 = 0x99 // ALS Lower Threshold Low Byte Register address ALS_Low_Threshold_Reg_1 = 0x9A // ALS Lower Threshold High Byte Register address

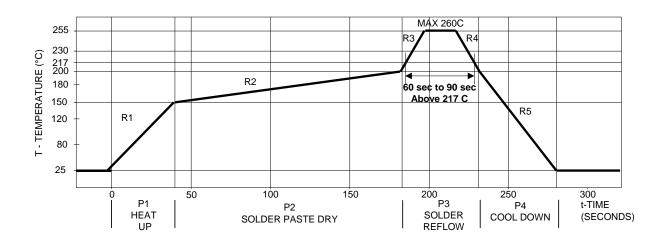
Data1 = 200 >> 8 // To convert decimal 200 into two eight bytes register values

Data0 = 200 & 0xFF

WriteByte(Slave_Addr, ALS_Low_Threshold_Reg_0, Data0) WriteByte(Slave_Addr, ALS_Low_Threshold_Reg_1, Data1) WriteByte(Slave_Addr, ALS_Upp_Threshold_Reg_1, Data1)



13. Recommended Leadfree Reflow Profile



Process Zone	S Zone Symbol		Maximum ∆T/∆time or Duration	
Heat Up	: Up P1, R1		3°C/s	
Solder Paste Dry	lder Paste Dry P2, R2		100s to 180s	
P3, R3		200°C to 260°C	3°C/s	
Solder Kellow	P3, R4	260°C to 200°C	-6°C/s	
Cool Down	P4, R5	200°C to 25°C	-6°C/s	
Time maintained above liquidu	s point , 217°C	> 217°C	60s to 90s	
Peak Temperature		260°C	-	
Time within 5°C of actual Peak	Temperature	> 255°C	20s	
Time 25°C to Peak Temperatu	re	25°C to 260°C	8mins	

It is recommended to perform reflow soldering no more than twice.



14. Moisture Proof Packaging

All LTR-303ALS-01 are shipped in moisture proof package. Once opened, moisture absorption begins. This part is compliant to JEDEC J-STD-033A Level 3.

Time from Unsealing to Soldering

After removal from the moisture barrier bag, the parts should be stored at the recommended storage conditions and soldered within seven days. When the moisture barrier bag is opened and the parts are exposed to the recommended storage conditions for more than seven days, the parts must be baked before reflow to prevent damage to the parts.

Recommended Storage Conditions

Storage Temperature	10°C to 30°C
Relative Humidity	Below 60% RH

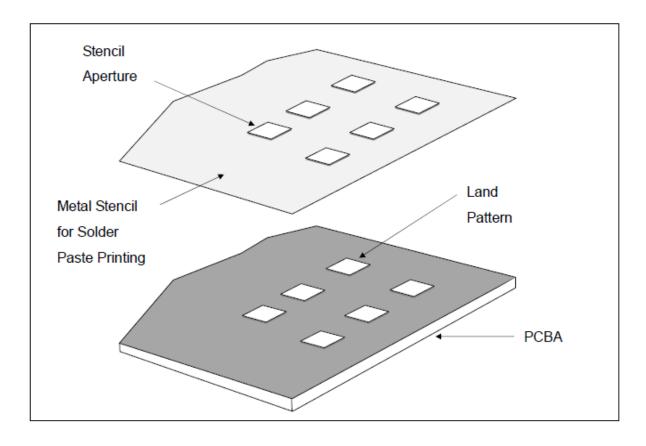
Baking Conditions

Package	Temperature	Time
In Reels	60°C	48 hours
In Bulk	100°C	4 hours

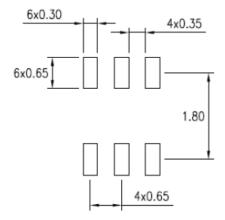
Baking should only be done once.



15. Recommended Land Pattern and Metal Stencil Aperture



Recommended Land Pattern



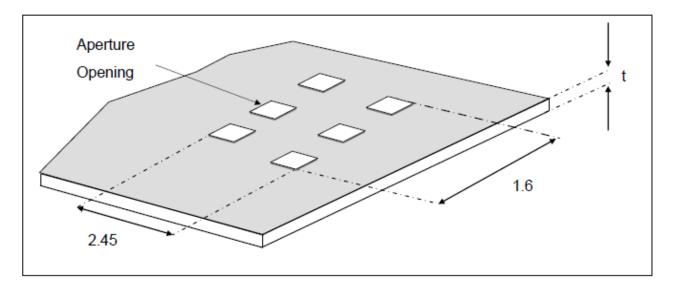
Note: All dimensions are in millimeters



Recommended Metal Stencil Aperture

It is recommended that the metal stencil used for solder paste printing has a thickness (t) of 0.11mm (0.004 inches / 4 mils) or 0.127mm (0.005 inches / 5 mils).

The stencil aperture opening is recommended to be 0.72mm x 0.60mm which has the same dimension as the land pattern. This is to ensure adequate printed solder paste volume and yet no shorting.



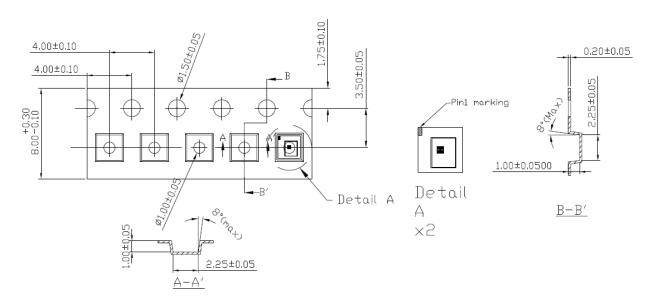
Note:

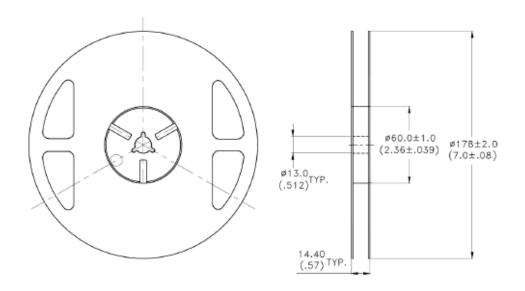
1. All dimensions are in millimeters

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16. Package Dimension for Tape and Reel





Notes:

- 1. All dimensions are in millimeters (inches)
- 2. Empty component pockets sealed with top cover tape
- 3. 7 inch reel 2500 pieces per reel
- 4. In accordance with ANSI/EIA 481-1-A-1994 specifications.

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